

# **DF451**

## **Fast Recovery Diode**

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## FEATURES

- Double Side Cooling
- High Surge Capability
- Low Recovery Charge

### Applications

- Induction Heating
- A.C. Motor Drives
- Inverters And Choppers
- Welding
- High Frequency Rectification
- UPS

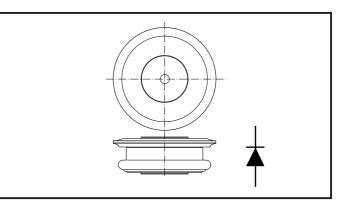
## Voltage Ratings

Type Number	Repetitive Peak Reverse Voltage V <sub>RRM</sub> V	Conditions
DF451 16	1600	$V_{RSM} = V_{RRM} + 100V$
DF451 14	1400	
DF451 12	1200	
DF451 10	1000	
DF451 08	800	
DF451 06	600	
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## **CURRENT RATINGS**

Symbol	Parameter	Conditions	Max.	Units	
Double Sid	Double Side Cooled				
I <sub>F(AV)</sub>	Mean forward current	Half wave resistive load, $T_{case} = 65^{\circ}C$	295	А	
I <sub>F(RMS)</sub>	RMS value	T <sub>case</sub> = 65°C	543	А	
I <sub>F</sub>	Continuous (direct) forward current	T <sub>case</sub> = 65°C	391	А	
Single Side Cooled (Anode side)					
I <sub>F(AV)</sub>	Mean forward current	Half wave resistive load, T <sub>case</sub> = 65°C	220	А	
I <sub>F(RMS)</sub>	RMS value	T <sub>case</sub> = 65°C	348	А	
l <sub>F</sub>	Continuous (direct) forward current	T <sub>case</sub> = 65°C	285	А	

<b>KEY PARAMETERS</b>		
$V_{RRM}$	1600V	
F(AV)	295A	
I <sub>FSM</sub>	3500A	
Q,	<b>25μC</b>	
t	<b>1.22</b> μs	



Outline type code: M771. See Package Details for further information.

## DF451

## SURGE RATINGS

Symbol	Parameter	Conditions	Max.	Units
I <sub>FSM</sub>	Surge (non-repetitive) forward current	10  ms half since with $0% V = T = 150%$	3.5	kA
l²t	I <sup>2</sup> t for fusing	10ms half sine; with 0% V <sub>RRM.</sub> T <sub>j</sub> = 150°C	61.25 x 10 <sup>3</sup>	A <sup>2</sup> s
I <sub>FSM</sub>	Surge (non-repetitive) forward current	10mc holf since with $50%$ V T = $150%$	2.8	kA
l <sup>2</sup> t	I <sup>2</sup> t for fusing	10ms half sine; with 50% V <sub>RRM.</sub> T <sub>j</sub> = 150°C	39.2 x 10 <sup>3</sup>	A <sup>2</sup> s

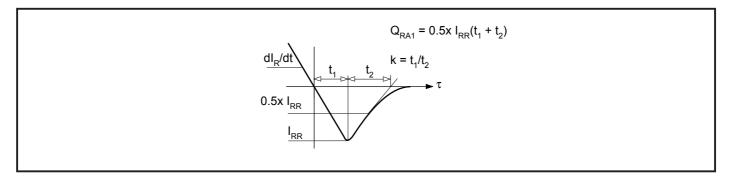
## THERMAL AND MECHANICAL DATA

Symbol	Parameter	Conditions		-	Max.	Units
		Double side cooled	dc	-	0.07	°C/W
R <sub>th(j-c)</sub>	Thermal resistance - junction to case	Single side cooled	Anode dc	-	0.133	°C/W
			Cathode dc	-	0.147	°C/W
R <sub>th(c-h)</sub>	Thermal resistance - case to heatsink	Clamping force 5.0kN with mounting compound	Double side	-	0.02	°C/W
			Single side	-	0.02	°C/W
T <sub>vj</sub>	Virtual junction temperature	Forward (conducting)		-	150	°C
T <sub>stg</sub>	Storage temperature range			-55	150	°C
-	Clamping force			4.5	5.5	kN

## CHARACTERISTICS

Symbol	Parameter	Conditions	Тур.	Max.	Units
$V_{\text{FM}}$	Forward voltage	At 600A peak, T <sub>case</sub> = 25°C	-	2.65	V
I <sub>RRM</sub>	Peak reverse current	At $V_{\text{RRM}}$ , $T_{\text{case}} = 125^{\circ}\text{C}$	-	100	mA
t <sub>rr</sub>	Reverse recovery time		1.22	-	μs
Q <sub>RA1</sub>	Recovered charge (50% chord)	I <sub>F</sub> = 500A, di <sub>RR</sub> /dt = -80A/μs	-	25	μC
I <sub>RM</sub>	Reverse recovery current	T <sub>case</sub> = 125°C, V <sub>R</sub> = 100V	-	40	Α
К	Soft factor		1.7	-	-
V <sub>to</sub>	Threshold voltage	At $T_{vj} = 125^{\circ}C$	-	1.6	V
r <sub>T</sub>	Slope resistance	At T <sub>vj</sub> = 125°C	-	1.5	mΩ
$V_{FRM}$	Forward recovery voltage	di/dt = 1000A/µs, T <sub>j</sub> = 125°C	-	40	V

# DEFINITION OF K FACTOR AND $\mathbf{Q}_{\text{RA1}}$



## **CURVES**

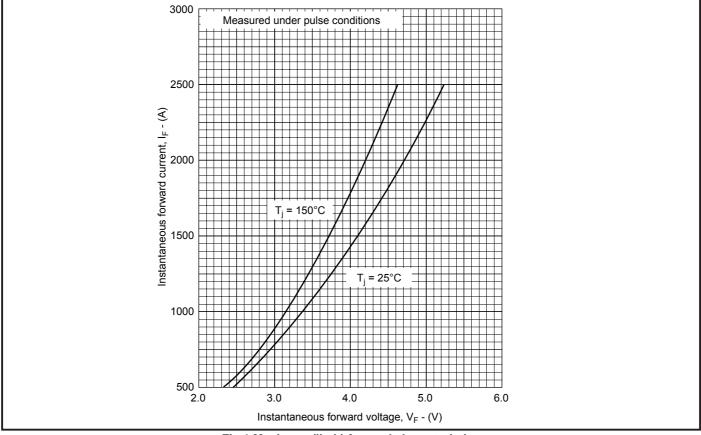


Fig.1 Maximum (limit) forward characteristics

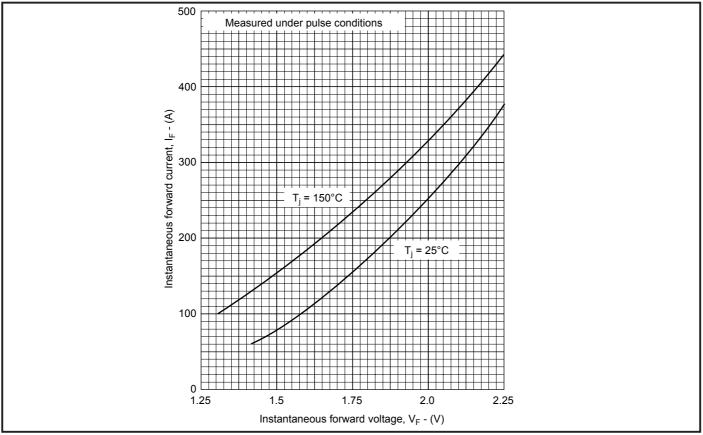


Fig.2 Maximum (limit) forward characteristics

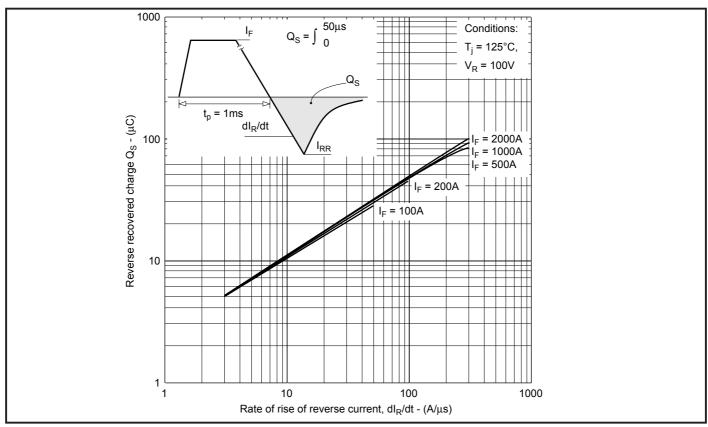


Fig.3 Recovered charge

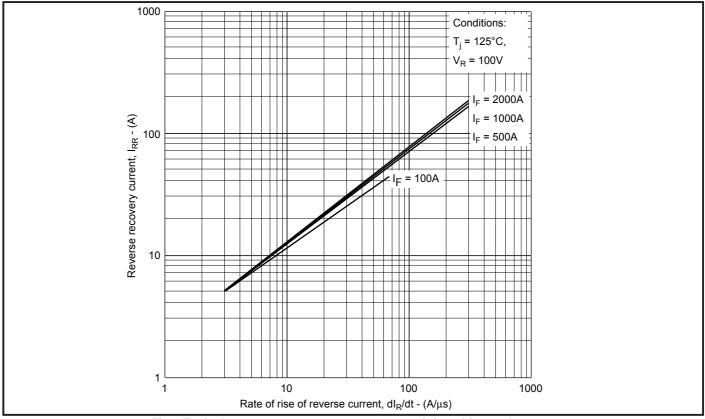


Fig.4 Typical reverse recovery current vs rate of rise of forward current

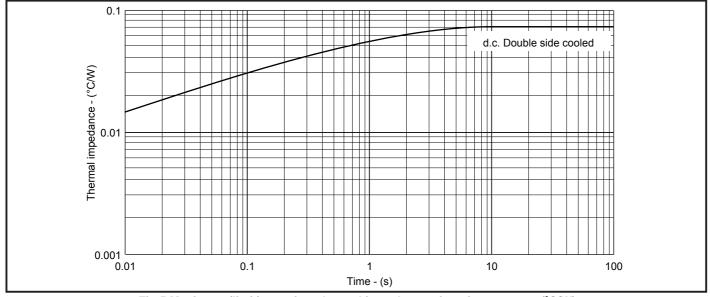
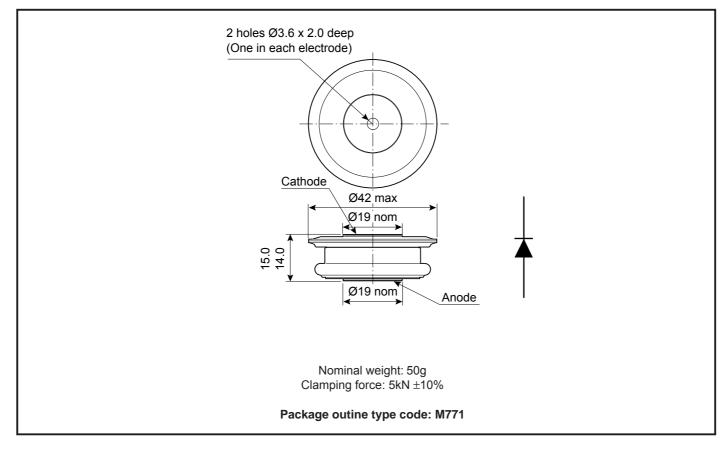


Fig.5 Maximum (limit) transient thermal impedance - junction to case - (°C/W)

## PACKAGE DETAILS

For further package information, please contact your local Customer Service Centre. All dimensions in mm, unless stated otherwise. DO NOT SCALE.





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